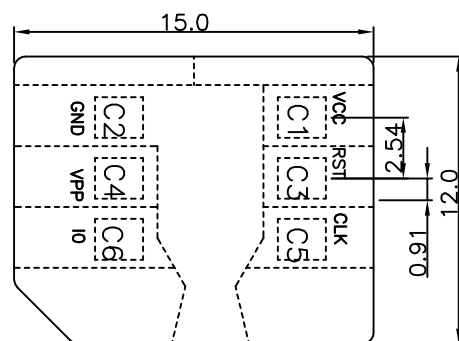
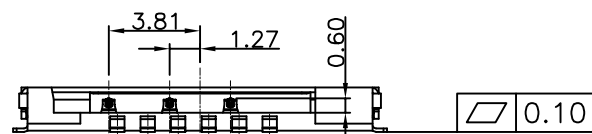
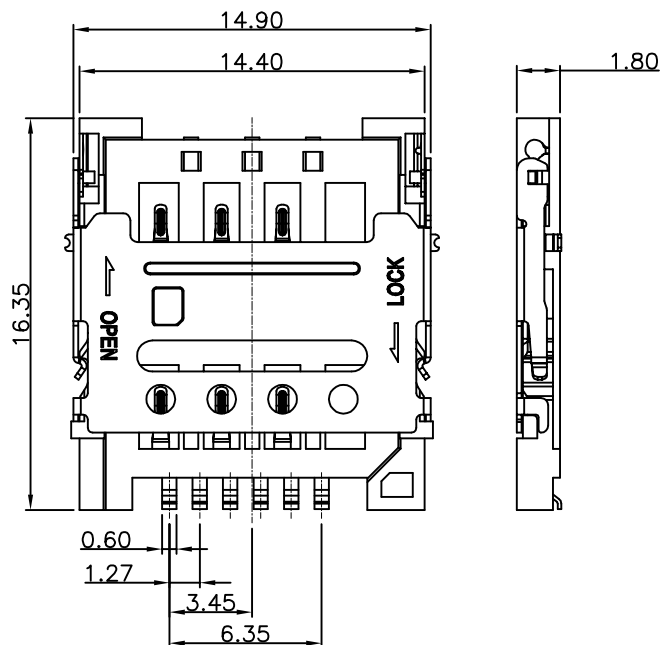
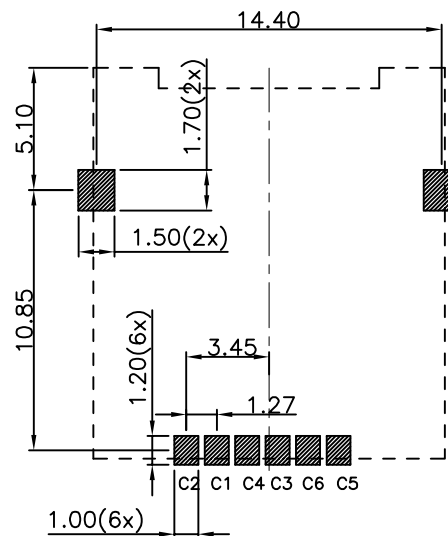
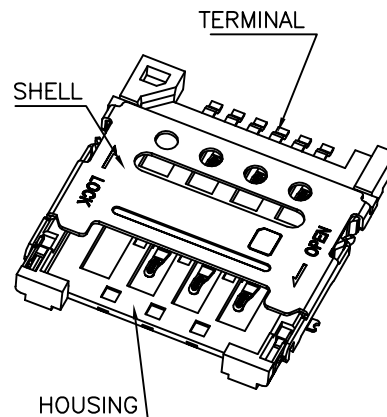


REV.	ECN.NO.	MODIFY.CONTENT	DATE
A0		NEW	2015/04/20



MICRO SIM



RECOMMENDED PCB LAYOUT(TOP VIEW)
GENERAL TOLERANCES:±0.05

NOTES:

1)MATERIAL:

HOUSING: LCP E130i UL 94V-0

CONTACT: C5210R-H T=0.15mm

SHELL: SUS201-H T=0.20mm

2)FINISH :

CONTACT:GOLD FLASH PLATED ON CONTACT AREA 1u"Min ;

GOLD FLASH PLATING ON SOLDER TAILS 1u"Min,

WITH ENTIRE CONTACT UNDERPLATED NICKEL 50u"Min

SHELL: NICKEL UNDERPLATED OVERALL 50u"Min,

3)MECHANICAL CHARACTERISTICS

CONTACT RETENTION: 50gf/pin Min

MATING CYCLE:3000 CYCLES

4)ELECTRICAL CHARACTERISTICS

RATING CURRENT: 1A

RATING VOLTAGE: 30V

CONTACT RESISTANCE: 30 MILLOHMS OHMS MAX

INSULATION RESISTANCE:

a, UNMATED: 1000M OHMS MIN

b, MATED: 100M OHMS MIN

DIELECTRIC WITHSTANDING VOLTAGE:

500V AC/1MINUTE

OPERATING TEPEPERATURE: -25°C---+70°C

STORAGE TEMPERATURE: -10°C---+40°C

MICRO SIM CARD	
PIN NO.	DESCRIPTION
P1	VCC
P2	GND
P3	RST
P4	VPP
P5	CLK
P6	I/O
P7	RESERVED
P8	RESERVED

GENERAL TOLERANCE

X.±0.45	x.'±5°
.XX±0.35	.x'±2°
.XX±0.25	.xx'±1°
.XXX±0.15	.xxx'±0.5°

DWG NO.

Title	MICRO SIM CARD 6PIN
Part NO.	5001B-SIM180-092

APPD:

CHKD:	
Date	2015/04/20

Scale

1:1

UNIT

mm

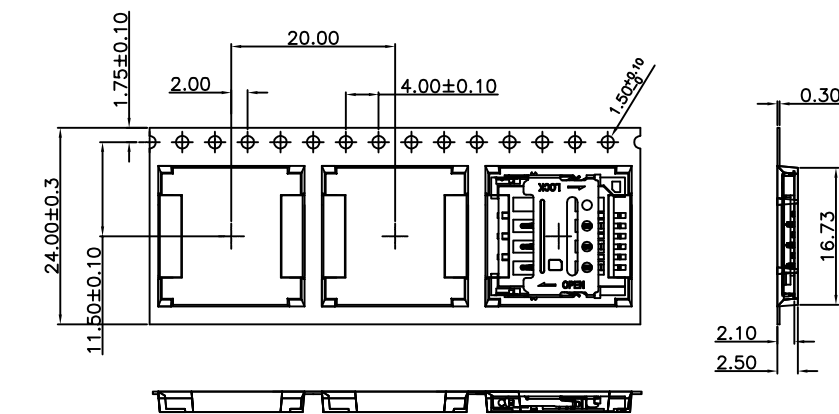
DR:

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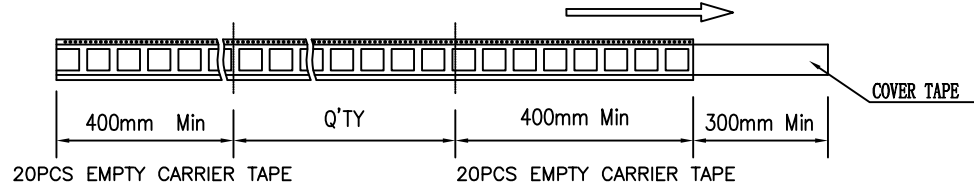
东莞市文章济美电子有限公司

REV.	ECN.NO.	MODIFY.CONTENT	DATE
A0		NEW	2015/04/20

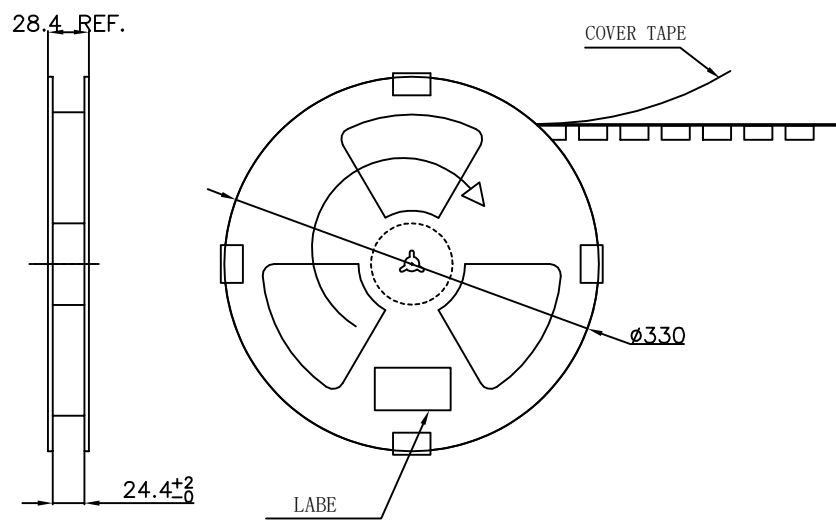
<图一>



放料方向



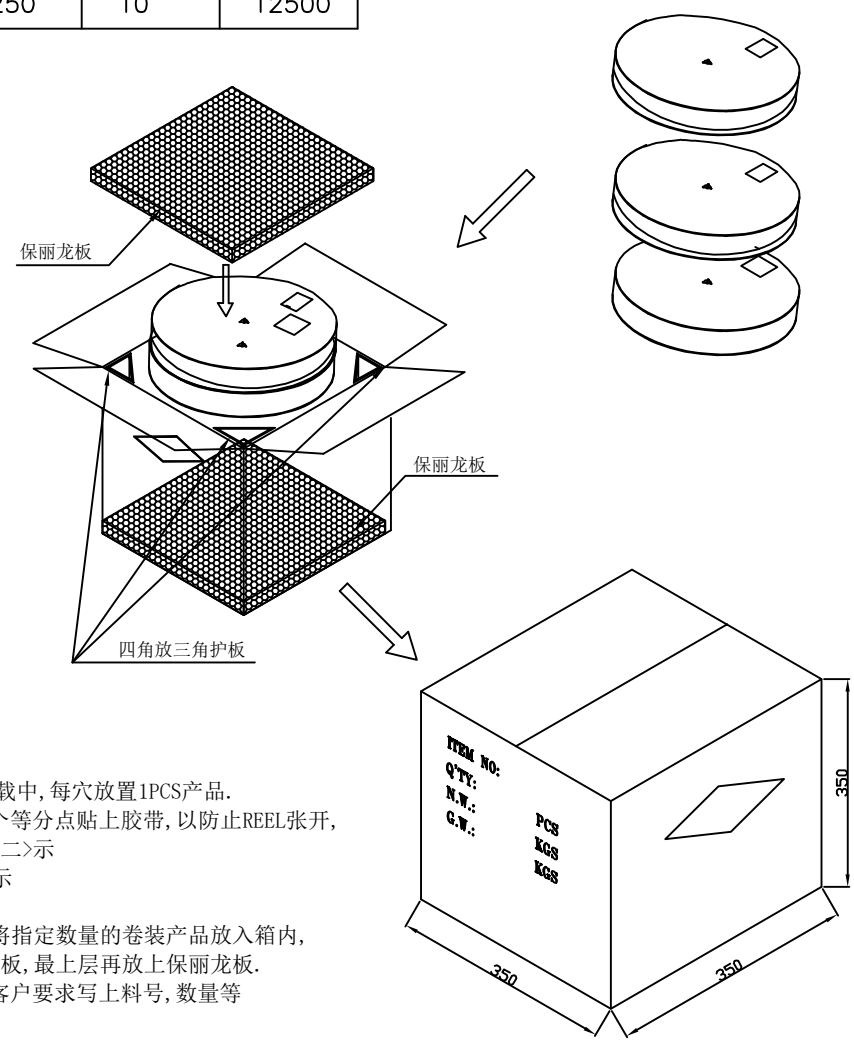
<图二>



<TABLE 1> PACKAGING QUANTITY

QTY/REEL	REEL/CARTON	QTY/CARTON
1250	10	12500

<图三>



NOTE:

1. 依<图一>示放置产品于下载中, 每穴放置1PCS产品.
2. 包装机包好后, 在REEL的个等分点贴上胶带, 以防止REEL张开, 每REEL贴1PCS标签, 如<图二>示
3. 包装数量见如<TABLE 1>示
4. 包装成箱见如<图三>示
箱底放保丽龙板, 再依次将指定数量的卷装产品放入箱内, 四角分别放入四个三角护板, 最上层再放上保丽龙板.
5. 封箱, 在封好的纸箱上按客户要求写上料号, 数量等

GENERAL TOLERANCE		图 号	设计	比例	1:1
X.±0.45	x.'±5'	品 名	MICRO SIM 6PIN CARD 掀盖式 包装图	审核	单位 mm
.X±0.35	.x'±2'			核准	
.XX±0.25	.xx'±1'	料 号	5001B-SIM180-092	日期	2015/04/20
.XXX±0.15	.xxx'±0.5'				
页号	2/2		东莞市文章济美电子有限公司		